

GBU10J thru GBU10M

GBU Package

Single Phase Glass Passivated Silicon Bridge Rectifier

V_{RRM} = 600 V -1000 V I_O = 10 A

Features

- Plastic package has Underwriters Laboratory
- Flammability Classification 94V-0
- High case dielectric strength of 1500 V_{RMS}
- Glass passivated chip junction
- · Ideal for printed circuit boards
- · High surge overload rating
- High temperature soldering guaranteed: 260°C/ 10 seconds, 0.375 (9.5mm) lead length
- Not ESD Sensitive

Mechanical Data

Case: Molded plastic body over passivated junctions Terminals: Plated leads, solderable per MIL-STD-750 Method 2026. Mounting position: Any

Maximum ratings at Tc = 25 °C, unless otherwise specified

| Parameter | Symbol | Conditions | GBU10J | GBU10K | GBU10M | Unit |
|---------------------------------|--------------------|------------|------------|------------|------------|------|
| Repetitive peak reverse voltage | e V _{RRM} | | 600 | 800 | 1000 | V |
| RMS reverse voltage | V _{RMS} | | 420 | 560 | 700 | V |
| DC blocking voltage | V _{DC} | | 600 | 800 | 1000 | V |
| Operating temperature | Tj | | -55 to 150 | -55 to 150 | -55 to 150 | °C |
| Storage temperature | T _{stg} | | -55 to 150 | -55 to 150 | -55 to 150 | °C |

Electrical characteristics at Tc = 25 °C, unless otherwise specified

Single phase, half sine wave, 60 Hz, resistive or inductive load.

For capacitive load derate current by 20%.

| Parameter | Symbol | Conditions | GBU10J | GBU10K | GBU10M | Unit |
|---|------------------|------------------------------------|--------|--------|--------|------|
| Maximum average forward rectified current ^{1,2} | Ι _Ο | T _c = 100 °C | 10.0 | 10.0 | 10.0 | А |
| Peak forward surge current | I _{FSM} | t _p = 8.3 ms, half sine | 220 | 220 | 220 | А |
| Maximum instantaneous forward voltage drop per leg | V _F | I _F = 10 A | 1.1 | 1.1 | 1.1 | V |
| Maximum DC reverse current at rated DC blocking voltage per leg | I _R | T _a = 25 °C | 5 | 5 | 5 | μΑ |
| | | T _a = 125 °C | 500 | 500 | 500 | |
| Typical junction capacitance per leg | C _j | | 70 | 70 | 70 | pF |
| Typical thermal resistance per leg ^{1,2} | R _{oJC} | | 2.2 | 2.2 | 2.2 | °C/W |

¹ - Device mounted on 100 mm x 100 mm x 1.6 mm Cu plate heatsink

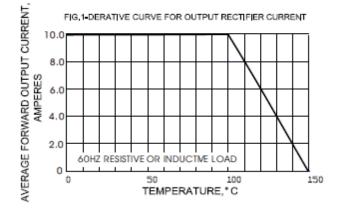
² - Recommended mounted position is to bolt down device on a heatsink with silicon thermal compond for maximum heat transfer using #6 screw.

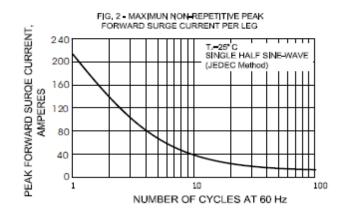
 3 - Measured at 1.0 MHz and applied reverse bias of 4.0 V

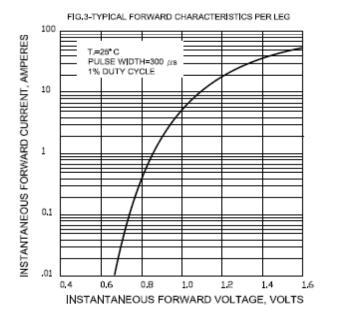


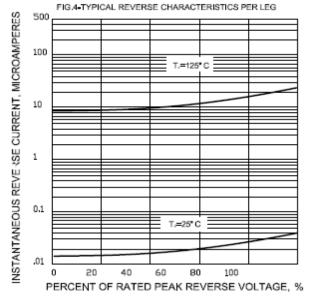


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Package dimensions and terminal configuration

Product is marked with part number and terminal configuration.

